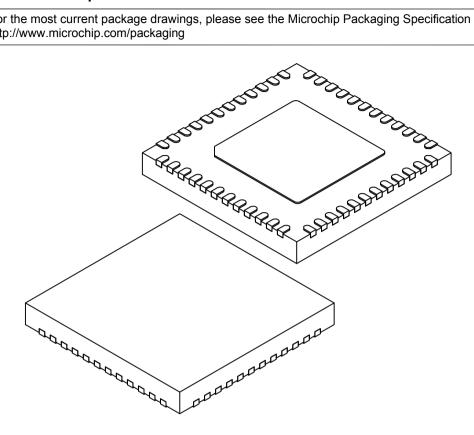
48-Lead Very Thin Quad Flat, No Lead Package (MYX) 7x7x0.9 mm Body [VQFN] With 4.04x4.12 mm Exposed Pad

For the most current package drawings, please see the Microchip Packaging Specification located at Note: http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Terminals	N	48		
Pitch	е	0.50 BSC		
Overall Height	Α	0.80	0.85	0.90
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.20 REF		
Overall Length	D	7.00 BSC		
Exposed Pad Length	D2	3.94	4.04	4.14
Overall Width	Е	7.00 BSC		
Exposed Pad Width	E2	4.02	4.12	4.22
Terminal Width	b	0.18	0.25	0.30
Terminal Length	L	0.35	0.40	0.45
Terminal-to-Exposed-Pad	K	1.04 REF		

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.